Vishay Semiconductors





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LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS							
Package FlatPAK 5 x 6							
I _{F(AV)}	2 x 3 A						
V _R	200 V						
V _F at I _F	0.71 V						
t _{rr (typ.)}	25 ns						
T _J max.	175 °C						
Circuit configuration	Separated cathode						

FEATURES

- Hyperfast recovery time, reduced Q_{rr}, and soft recovery
- 175 °C maximum operating junction temperature
- Specific for output and snubber operation
- Low forward voltage drop
- Low leakage current
- AEC-Q101 qualified
- Meets MSL level 1 per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

State of the art hyperfast recovery rectifiers specifically designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness, and reliability characteristics.

These devices are intended for use in snubber, boost, piezo-injection, as high frequency rectifiers, and freewheeling diodes.

The extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element.

MECHANICAL DATA

Case: FlatPAK 5 x 6

Molding compound meets UL 94 V-0 flammability rating Halogen-free, RoHS-compliant

Terminals: matte tin plated leads, solderable per J-STD-002, meets JESD 201 class 2 whisker test

ABSOLUTE MAXIMUM RATINGS								
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Peak repetitive reverse voltage		V _{RRM}		200	V			
Average rectified forward current	per	I _{F(AV)}	T _{Solderpad} = 170 °C, DC	6				
Average rectilied forward current	device	·F(AV)	$T_{Solderpad} = 169 \ ^{\circ}C, D = 0.5$	0				
Non-repetitive peak surge current	per device	I _{FSM}	T_J = 25 °C, 10 ms sinusoidal pulse	173	A			
	per diode			87				
Operating junction and storage temp	eratures	T _J , T _{Stg}		-55 to +175	°C			

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1



ROHS COMPLIANT

HALOGEN



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ELECTRICAL SPECIFICATIONS (T _J = 25 $^{\circ}$ C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	200	-	-			
Forward voltage, per diode	V _F	I _F = 3 A	-	0.88	0.94	V		
		I _F = 3 A, T _J = 150 °C	-	0.71	0.74			
Reverse leakage current, per diode	I _R	$V_{R} = V_{R}$ rated	-	-	2			
		$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	2	40	μA		
Junction capacitance	CT	V _R = 200 V	-	14	-	pF		

DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25 \text{ °C}$ unless otherwise specified)									
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS		
		$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t =$	= 50 A/µs, V _R = 30 V	-	20	-			
Reverse recovery time	t _{rr}	I _F = 0.5 A, I _R = 1 A, I _{rr} = 0.25 A		-	-	25			
		T _J = 25 °C		-	15	-	ns		
		T _J = 125 °C		-	25	-			
Pools receivers ourrent		T _J = 25 °C	I _F = 3 A dI _F /dt = 200 A/μs V _B = 160 V	-	2	-	А		
Peak recovery current	I _{RRM}	T _J = 125 °C		-	3	-	A		
Reverse recovery charge	Q _{rr}	T _J = 25 °C		-	12	-	nC		
		T _J = 125 °C		-	40	-	10		

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Maximum junction and storage temperature range	T _J , T _{Stg}		-55	-	175	°C		
Thermal resistance, junction to ambient, per diode	R _{thJA} ⁽¹⁾⁽²⁾		-	90	103	°C/W		
Thermal resistance, junction to mount, per diode	R _{thJM} ⁽³⁾		-	2.3	2.6	0/11		

Notes

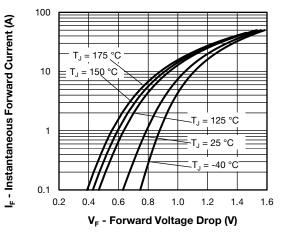
 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{thJA}$

 $^{(2)}$ Free air, mounted or recommended copper pad area; thermal resistance R_{thJA} - junction to ambient

⁽³⁾ Mounted on infinite heatsink



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Fig. 1 - Typical Forward Voltage Drop Characteristics

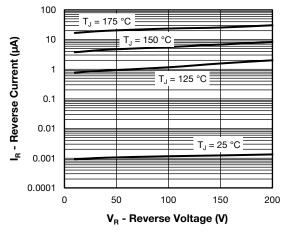


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

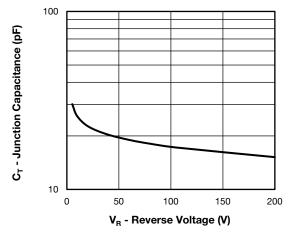


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

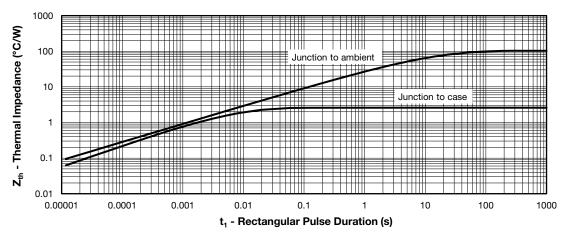
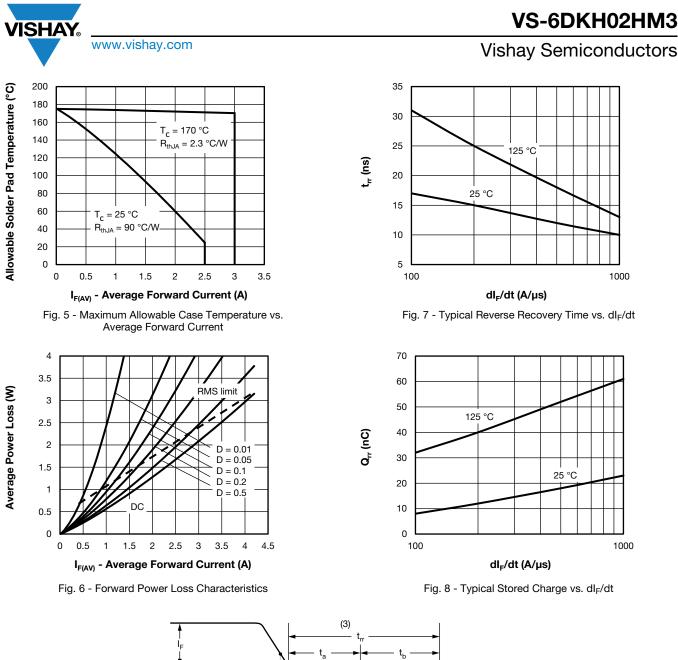


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

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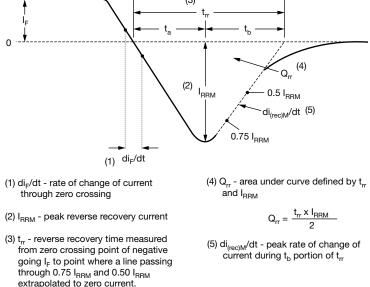


Fig. 9 - Reverse Recovery Waveform and Definitions

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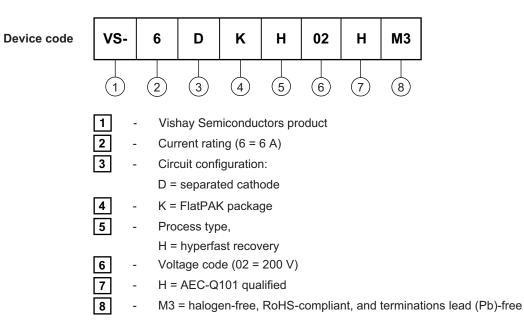
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ORDERING INFORMATION TABLE



ORDERING INFORMATION (example)								
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE BASE QUANTITY PACKAGING DESCRIPTION						
VS-6DKH02HM3/H	0.10	н	1500	7"diameter plastic tape and reel				

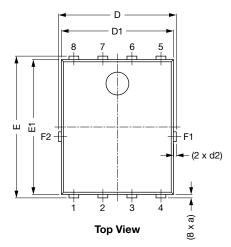
LINKS TO RELATED DOCUMENTS						
Dimensions www.vishay.com/doc?96056						
Part marking information	www.vishay.com/doc?96059					
Packaging information	www.vishay.com/doc?88869					
SPICE model	www.vishay.com/doc?96882					

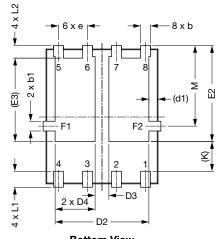




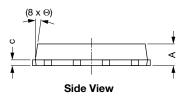
FlatPAK 5 x 6 (Dual)

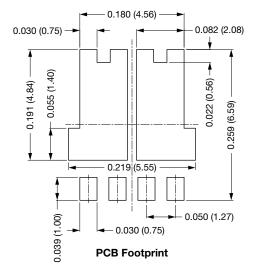
DIMENSIONS in inches (millimeters)











DIM	INCHES		MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	0.035	0.039	0.043	0.89	0.99	1.09
(a)	-	0.006	-	-	0.15	-
b	0.013	0.017	0.020	0.32	0.43	0.52
b1	0.013	0.017	0.020	0.32	0.43	0.52
С	0.008	-	0.014	0.20	-	0.35
D	0.197	0.203	0.209	5.00	5.15	5.30
D1	0.189	0.193	0.197	4.80	4.90	5.00
D2	0.154	0.161	0.169	3.90	4.10	4.30
D3	0.020	0.024	0.031	0.50	0.60	0.80
D4	0.063	0.069	0.075	1.60	1.75	1.90
(d1)	-	0.016	-	-	0.40	-
(d2)	-	0.005	-	-	0.125	-
E	0.238	0.244	0.250	6.05	6.20	6.35

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Outline Dimensions



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DIM.		INCHES			MILLIMETERS		
DIN.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
E1	0.228	0.232	0.236	5.80	5.90	6.00	
E2	0.157	0.165	0.173	4.00	4.20	4.40	
(E3)	-	0.144	-	-	3.65	-	
е		0.050 BSC		1.27 BSC			
(K)	0.039	-	-	1.00	-	-	
L1	0.019	-	0.043	0.48	-	1.10	
L2	0.012	-	0.031	0.30	-	0.80	
М	0.128	0.138	0.148	3.25	3.50	3.75	
Θ	0°	-	10°	0°	-	10°	

Notes

٠ Dimensioning and tolerancing per ASME Y14.5-2009

Dimensions D1 and E1 do not include mold flash or gate burrs ٠

Dimension (XX) means reference only ٠



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